



Process Information

ACF/Heat Seal
(check all that apply)

Solder Reflow
(check all that apply)

ACF/Heat Seal (check all that apply)		Solder Reflow (check all that apply)	
TAB	To	Flex or TAB	To
Chip	Glass LCD	Connector	PCB (FR4)
	Flat Panel Display		Flex or TAB
Flex	PCB	Device	Ceramic
Heat Seal	Ceramic	Wire	Other
Connector	Other	Other	
		Flat Leads	Round Leads

Dimensions and Description

All dimensions in mm

Lead Pitch: _____

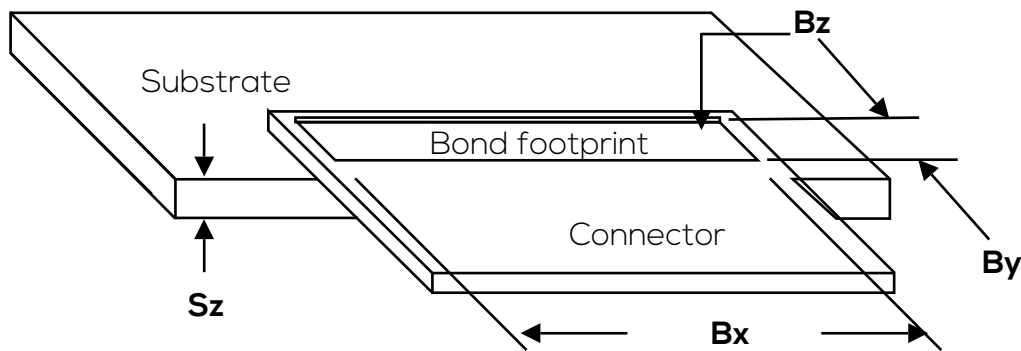
X-axis Footprint, Bx: _____

Y-axis Footprint, By: _____

Connector lead Thickness, Bz: _____

Substrate Thickness, Sz: _____

Flux/Solder/ACF: _____



Note: if there are multiple bonding sites, please attach with additional dimension and description information

Contact Name _____ Company _____

Phone Number _____ Today's Date _____

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